

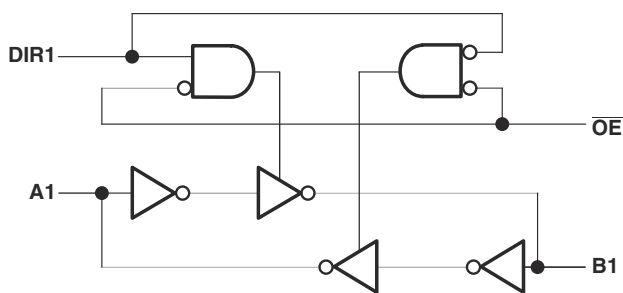
具有可配置电平转换/电压转换和三态输出的 SN74AVC2T245 2 位双电源总线收发器

1 特性

- 每个通道都具有独立方向控制
- 控制输入电平 V_{IH}/V_{IL} 以 V_{CCA} 电压为基准
- 完全可配置的双轨设计，支持各个端口在 1.2V 至 3.6V 的
整个电源电压范围内运行
- I/O 可承受 4.6V 的电压
- I_{off} 支持局部省电模式运行
- V_{CC} 隔离特性 - 如果任何一个 V_{CC} 输入接地 (GND)，则两个端口均处于高阻抗状态
- 典型数据速率
 - 500Mbps (1.8V 至 3.3V 电平转换)
 - 320Mbps (<1.8V 至 3.3V 电平转换)
 - 320Mbps (转换至 2.5V 或 1.8V)
 - 280Mbps (转换至 1.5V)
 - 240Mbps (转换至 1.2V)
- 闩锁性能超过 100mA，符合 JESD 78 II 类规范的要求
- ESD 保护性能超过 JESD 22 规范要求
 - 5000V 人体放电模型 (A114-A)
 - 200V 机器放电模型 (A115-A)
 - 1500V 充电器件模型 (C101)

2 应用

- 个人电子产品
- 工业
- 企业级
- 电信



A. 本图针对的是单通道

逻辑图 (正逻辑)

3 说明

这款 2 位同相总线收发器使用两个独立的可配置电源轨。A 端口旨在跟踪 V_{CCA} 。 V_{CCA} 电源电压为 1.2V 至 3.6V。B 端口旨在跟踪 V_{CCB} 。 V_{CCB} 电源电压为 1.2V 至 3.6V。因此可在 1.2V、1.5V、1.8V、2.5V 和 3.3V 电压节点之间进行通用的低电压双向转换。

SN74AVC2T245 旨在实现两条数据总线间的异步通信。方向控制 (DIR) 输入和输出使能 ($\overline{OE}$) 的逻辑电平激活 B 端口输出或者 A 端口输出，或者将两个输出端口都置于高阻抗模式。当 B 端口输出被激活时，此器件将数据从 A 总线发送到 B 总线，而当 A 端口输出被激活时，此器件将数据从 B 总线发送到 A 总线。A 端口和 B 端口上的输入电路一直处于激活状态并且必须施加一个逻辑高或低电平，从而防止过大的 I_{CC} 和 I_{CCZ} 。

SN74AVC2T245 的控制引脚 (DIR1、DIR2 和 $\overline{OE}$) 由 V_{CCA} 供电。

该器件专用于使用 I_{off} 的局部断电应用。 I_{off} 电路可禁用输出，以防在器件断电时电流回流对器件造成损坏。

V_{CC} 隔离特性可确保只要有任何一个 V_{CC} 输入接地 (GND)，则两个端口均处于高阻抗状态。

为了确保上电或下电期间的高阻抗状态， $\overline{OE}$ 必须通过一个上拉电阻器连接至 V_{CC} ；该电阻器的最小阻值由驱动器的电流灌入能力来决定。

器件信息

器件型号	封装 ⁽¹⁾	封装尺寸 (标称值)
SN74AVC2T245	UQFN (10)	1.80mm × 1.40mm

(1) 如需了解所有可用封装，请参阅数据表末尾的可订购产品附录。



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4 Pin Configuration and Functions

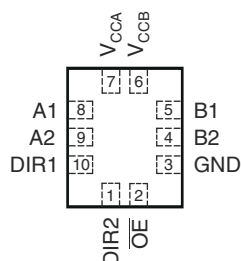


图 4-1. RSW PACKAGE 10-PIN UQFN TOP VIEW

表 4-1. Pin Functions

PIN		DESCRIPTION
NAME	NO. (UQFN)	
V_{CCA}	7	Supply Voltage A
V_{CCB}	6	Supply Voltage B
GND	3	Ground
A1	8	Output or input depending on state of DIR. Output level depends on V_{CCA} .
A2	9	Output or input depending on state of DIR. Output level depends on V_{CCA} .
B1	5	Output or input depending on state of DIR. Output level depends on V_{CCB} .
B2	4	Output or input depending on state of DIR. Output level depends on V_{CCB} .
DIR1, DIR2	10, 1	Direction Pin, Connect to GND or to V_{CCA}
$\overline{OE}$	2	Tri-state output-mode enables. Pull OE high to place all outputs in 3-state mode. Referenced to V_{CCA}

5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

			MIN	MAX	UNIT
V_{CCA} V_{CCB}	Supply voltage		– 0.5	4.6	V
V_I	Input voltage ⁽²⁾	I/O ports (A port)	– 0.5	4.6	V
		I/O ports (B port)	– 0.5	4.6	
		Control inputs	– 0.5	4.6	
V_O	Voltage applied to any output in the high-impedance or power-off state ⁽²⁾	A port	– 0.5	4.6	V
		B port	– 0.5	4.6	
V_O	Voltage applied to any output in the high or low state ⁽²⁾ (3)	A port	– 0.5	$V_{CCA} + 0.5$	V
		B port	– 0.5	$V_{CCB} + 0.5$	
I_{IK}	Input clamp current	$V_I < 0$		– 50	mA
I_{OK}	Output clamp current	$V_O < 0$		– 50	mA
I_O	Continuous output current			±50	mA
	Continuous current through V_{CCA} , V_{CCB} , or GND			±100	mA
T_J	Junction Temperature		–40	150	°C
T_{stg}	Storage temperature range		– 65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

5.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	5000	V
		Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	1500	

- (1) JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250 V CDM allows safe manufacturing with a standard ESD control process.

5.3 Recommended Operating Conditions

(3)			V_{CCI}	V_{CCO}	MIN	MAX	UNIT
V_{CCA}	Supply voltage				1.2	3.6	V
V_{CCB}	Supply voltage				1.2	3.6	V
V_{IH}	High-level input voltage	Data inputs ⁽¹⁾	1.2 V to 1.95 V		$V_{CCI} \times 0.65$		V
			1.95 V to 2.7 V		1.6		
			2.7 V to 3.6 V		2		
V_{IL}	Low-level input voltage	Data inputs ⁽¹⁾	1.2 V to 1.95 V		$V_{CCI} \times 0.35$		V
			1.95 V to 2.7 V		0.7		
			2.7 V to 3.6 V		0.8		
V_{IH}	High-level input voltage	DIR (referenced to V_{CCA}) ⁽²⁾	1.2 V to 1.95 V		$V_{CCA} \times 0.65$		V
			1.95 V to 2.7 V		1.6		
			2.7 V to 3.6 V		2		

5.3 Recommended Operating Conditions (续)

(3)			V _{CCI}	V _{CCO}	MIN	MAX	UNIT
V _{IL}	Low-level input voltage	DIR (referenced to V _{CCA}) ⁽²⁾	1.2 V to 1.95 V		V _{CCA} × 0.35		V
			1.95 V to 2.7 V		0.7		
			2.7 V to 3.6 V		0.8		
V _I	Input voltage				0	3.6	V
V _O	Output voltage	Active state			0	V _{CCO}	V
		3-state			0	3.6	
I _{OH}	High-level output current			1.1 V to 1.2 V	– 3		mA
				1.4 V to 1.6 V	– 6		
				1.65 V to 1.95 V	– 8		
				2.3 V to 2.7 V	– 9		
				3 V to 3.6 V	– 12		
I _{OL}	Low-level output current			1.1 V to 1.2 V	3		mA
				1.4 V to 1.6 V	6		
				1.65 V to 1.95 V	8		
				2.3 V to 2.7 V	9		
				3 V to 3.6 V	12		
Δ t / Δ v Input transition rise or fall rate					5		ns/V
T _A	Operating free-air temperature				– 40	85	°C

- (1) V_{CCI} is the V_{CC} associated with the input port.
 (2) V_{CCO} is the V_{CC} associated with the output port.
 (3) All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

5.4 Thermal Information

THERMAL METRIC ⁽¹⁾		SN74AVC2T245	UNIT
		RSW (UQFN)	
		10 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	227.4	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	96.3	°C/W
R _{θJB}	Junction-to-board thermal resistance	139.6	°C/W
ψ _{JT}	Junction-to-top characterization parameter	5.2	°C/W
ψ _{JB}	Junction-to-board characterization parameter	139.2	°C/W
R _{θJC(bot)}	Junction-to-case (bottom) thermal resistance	N/A	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

5.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)^{(1) (2)}

PARAMETER		TEST CONDITIONS	V _{CCA}	V _{CCB}	T _A = 25°C			- 40°C to 85°C		UNIT
					MIN	TYP	MAX	MIN	MAX	
V _{OH}		I _{OH} = - 100 μA	1.2 V to 3.6 V	1.2 V to 3.6 V				V _{CCO} - 0.2		V
		I _{OH} = - 3 mA	1.2 V	1.2 V		0.95				
		I _{OH} = - 6 mA	1.4 V	1.4 V				1.05		
		I _{OH} = - 8 mA	1.65 V	1.65 V				1.2		
		I _{OH} = - 9 mA	2.3 V	2.3 V				1.75		
		I _{OH} = - 12 mA	3 V	3 V				2.3		
V _{OL}		I _{OL} = 100 μA	1.2 V to 3.6 V	1.2 V to 3.6 V					0.2	V
		I _{OL} = 3 mA	1.2 V	1.2 V		0.25				
		I _{OL} = 6 mA	1.4 V	1.4 V				0.35		
		I _{OL} = 8 mA	1.65 V	1.65 V				0.45		
		I _{OL} = 9 mA	2.3 V	2.3 V				0.55		
		I _{OL} = 12 mA	3 V	3 V				0.7		
I _I	Control inputs	V _I = V _{CCA} or GND	1.2 V to 3.6 V	1.2 V to 3.6 V		±0.025	±0.25		±1	μA
I _{off}	A or B port	V _I or V _O = 0 to 3.6 V	0 V	0 V to 3.6 V		±0.1	±1		±5	μA
			0 V to 3.6 V	0 V		±0.1	±1		±5	
I _{OZ}	A or B port	V _O = V _{CCO} or GND, V _I = V _{CCI} or GND, $\overline{OE}$ = V _{IH}	3.6 V	3.6 V		±0.5	±2.5		±5	μA
I _{CCA}		V _I = V _{CCI} or GND, I _O = 0	1.2 V to 3.6 V	1.2 V to 3.6 V					8	μA
			0 V	0 V to 3.6 V					- 2	
			0 V to 3.6 V	0 V					8	
I _{CCB}		V _I = V _{CCI} or GND, I _O = 0	1.2 V to 3.6 V	1.2 V to 3.6 V					8	μA
			0 V	0 V to 3.6 V					8	
			0 V to 3.6 V	0 V					- 2	
I _{CCA} + I _{CCB}		V _I = V _{CCI} or GND, I _O = 0	1.2 V to 3.6 V	1.2 V to 3.6 V					16	μA
C _i	Control inputs	V _I = 3.3 V or GND	3.3 V	3.3 V		3.5			4.5	pF
C _{io}	A or B port	V _O = 3.3 V or GND	3.3 V	3.3 V		6			7	pF

(1) V_{CCO} is the V_{CC} associated with the output port.

(2) V_{CCI} is the V_{CC} associated with the input port.

5.6 Switching Characteristics: $V_{CCA} = 1.2\text{ V}$

over recommended operating free-air temperature range, $V_{CCA} = 1.2\text{ V}$ (unless otherwise noted) (see 图 6-1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2\text{ V}$	$V_{CCB} = 1.5\text{ V} \pm 0.1\text{ V}$	$V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$	$V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$	$V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$	UNIT
			TYP	TYP	TYP	TYP	TYP	
t_{PLH}	A	B	2.5	2.1	1.9	1.9	1.9	ns
t_{PHL}			2.5	2.1	1.9	1.9	1.9	
t_{PLH}	B	A	2.5	2.2	2	1.8	1.7	ns
t_{PHL}			2.5	2.2	2	1.8	1.7	
t_{PZH}	$\overline{OE}$	A	3.8	3.1	2.7	2.6	3	ns
t_{PZL}			3.8	3.1	2.7	2.6	3	
t_{PZH}	$\overline{OE}$	B	3.7	3.7	3.7	3.7	3.7	ns
t_{PZL}			3.7	3.7	3.7	3.7	3.7	
t_{PHZ}	$\overline{OE}$	A	4.4	3.6	3.5	3.3	4.1	ns
t_{PLZ}			4.4	3.6	3.5	3.3	4.1	
t_{PHZ}	$\overline{OE}$	B	4.2	4.2	4.3	4.1	4.2	ns
t_{PLZ}			4.2	4.2	4.3	4.1	4.2	

5.7 Switching Characteristics: $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$

over recommended operating free-air temperature range, $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$ (see 图 6-1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2\text{ V}$	$V_{CCB} = 1.5\text{ V} \pm 0.1\text{ V}$		$V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$		$V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$		$V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A	B	2.2	0.3	4.4	0.2	3.9	0.1	3.6	0.1	3.9	ns
t_{PHL}			2.2	0.3	4.4	0.2	3.9	0.1	3.6	0.1	3.9	
t_{PLH}	B	A	2	0.6	5.1	0.4	4.9	0.2	4.6	0.1	4.5	ns
t_{PHL}			2	0.6	5.1	0.4	4.9	0.2	4.6	0.1	4.5	
t_{PZH}	$\overline{OE}$	A	3.4	1.1	7.1	0.9	6.2	0.7	5.5	0.1	6.4	ns
t_{PZL}			3.4	1.1	7.1	0.9	6.2	0.7	5.5	0.1	6.4	
t_{PZH}	$\overline{OE}$	B	2.5	1.1	8.2	1.1	8.2	1.1	8.2	1.1	8.2	ns
t_{PZL}			2.5	1.1	8.2	1.1	8.2	1.1	8.2	1.1	8.2	
t_{PHZ}	$\overline{OE}$	A	4.1	1.2	7.1	0.8	6.7	0.4	5.6	1	7.4	ns
t_{PLZ}			4.1	1.2	7.1	0.8	6.7	0.4	5.6	1	7.4	
t_{PHZ}	$\overline{OE}$	B	3.3	0.3	7.4	0.2	5.7	0.3	5.6	0.3	5.6	ns
t_{PLZ}			3.3	0.3	7.4	0.2	5.7	0.3	5.6	0.3	5.6	

5.8 Switching Characteristics: $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$

over recommended operating free-air temperature range, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (see 图 6-1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A	B	2	0.1	4.1	0.1	3.6	0.1	3.1	0.1	3.3	ns
t_{PHL}			2	0.1	4.1	0.1	3.6	0.1	3.1	0.1	3.3	
t_{PLH}	B	A	1.9	0.4	4.3	0.1	4.1	0.1	3.8	0.1	3.7	ns
t_{PHL}			1.9	0.4	4.3	0.1	4.1	0.1	3.8	0.1	3.7	
t_{PZH}	$\overline{OE}$	A	3.2	0.8	6.7	0.4	5.8	0.4	4.8	0.3	4.6	ns
t_{PZL}			3.2	0.8	6.7	0.4	5.8	0.4	4.8	0.3	4.6	
t_{PZH}	$\overline{OE}$	B	1.9	0.2	6.7	0.2	6.6	0.2	6.7	0.2	6.7	ns
t_{PZL}			1.9	0.2	6.7	0.2	6.6	0.2	6.7	0.2	6.7	
t_{PHZ}	$\overline{OE}$	A	3.8	0.7	6.2	0.3	6.5	0.1	5.2	0.8	6.5	ns
t_{PLZ}			3.8	0.7	6.2	0.3	6.5	0.1	5.2	0.8	6.5	
t_{PHZ}	$\overline{OE}$	B	3.4	0.1	6.8	0.1	6.8	0.1	6.7	0.1	6.7	ns
t_{PLZ}			3.4	0.1	6.8	0.1	6.8	0.1	6.7	0.1	6.7	

5.9 Switching Characteristics: $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$

over recommended operating free-air temperature range, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (see 图 6-1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A	B	1.9	0.1	3.8	0.1	3.2	0.1	2.7	0.1	2.6	ns
t_{PHL}			1.9	0.1	3.8	0.1	3.2	0.1	2.7	0.1	2.6	
t_{PLH}	B	A	1.8	0.5	3.4	0.2	3.1	0.1	2.8	0.1	2.6	ns
t_{PHL}			1.8	0.5	3.4	0.2	3.1	0.1	2.8	0.1	2.6	
t_{PZH}	$\overline{OE}$	A	3.1	0.7	6.2	0.5	5.2	0.3	4.1	0.3	3.6	ns
t_{PZL}			3.1	0.7	6.2	0.5	5.2	0.3	4.1	0.3	3.6	
t_{PZH}	$\overline{OE}$	B	1.4	0.4	4.5	0.4	4.5	0.4	4.5	0.4	4.5	ns
t_{PZL}			1.4	0.4	4.5	0.4	4.5	0.4	4.5	0.4	4.5	
t_{PHZ}	$\overline{OE}$	A	3.6	0.2	5.2	0.1	5.4	0.1	4.5	0.7	6	ns
t_{PLZ}			3.6	0.2	5.2	0.1	5.4	0.1	4.5	0.7	6	
t_{PHZ}	$\overline{OE}$	B	2.1	0.1	4.7	0.1	4.6	0.1	4.7	0.1	4.7	ns
t_{PLZ}			2.1	0.1	4.7	0.1	4.6	0.1	4.7	0.1	4.7	

5.10 Switching Characteristics: $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$

over recommended operating free-air temperature range, $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$ (see 图 6-1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2\text{ V}$	$V_{CCB} = 1.5\text{ V} \pm 0.1\text{ V}$		$V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$		$V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$		$V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A	B	1.8	0.1	3.6	0.1	3	0.1	2.6	0.1	2.4	ns
t_{PHL}			1.8	0.1	3.6	0.1	3	0.1	2.6	0.1	2.4	
t_{PLH}	B	A	1.9	0.5	3.4	0.2	2.9	0.1	2.5	0.1	2.3	ns
t_{PHL}			1.9	0.5	3.4	0.2	2.9	0.1	2.5	0.1	2.3	
t_{PZH}	$\overline{OE}$	A	3.1	0.9	5.9	0.5	5	0.3	3.8	0.3	3.3	ns
t_{PZL}			3.1	0.9	5.9	0.5	5	0.3	3.8	0.3	3.3	
t_{PZH}	$\overline{OE}$	B	1.2	0.4	3.6	0.4	3.6	0.4	3.6	0.4	3.6	ns
t_{PZL}			1.2	0.4	3.6	0.4	3.6	0.4	3.6	0.4	3.6	
t_{PHZ}	$\overline{OE}$	A	3.4	0.1	4.6	0.1	4.7	0.3	4.8	0.7	4.5	ns
t_{PLZ}			3.4	0.1	4.6	0.1	4.7	0.3	4.8	0.7	4.5	
t_{PHZ}	$\overline{OE}$	B	2.9	0.1	5.4	0.1	5.3	0.1	5.3	0.1	5.3	ns
t_{PLZ}			2.9	0.1	5.4	0.1	5.3	0.1	5.3	0.1	5.3	

5.11 Operating Characteristics

$T_A = 25^\circ\text{C}$

PARAMETER			TEST CONDITIONS	$V_{CCA} =$ $V_{CCB} = 1.2\text{ V}$	$V_{CCA} =$ $V_{CCB} = 1.5\text{ V}$	$V_{CCA} =$ $V_{CCB} = 1.8\text{ V}$	$V_{CCA} =$ $V_{CCB} = 2.5\text{ V}$	$V_{CCA} =$ $V_{CCB} = 3.3\text{ V}$	UNIT
				TYP	TYP	TYP	TYP	TYP	
C_{pdA} ⁽¹⁾	A to B	Outputs enabled	$C_L = 0,$ $f = 10\text{ MHz},$ $t_r = t_f = 1\text{ ns}$	3	3	3	3	4	pF
		Outputs disabled		1	1	1	2	2	
	B to A	Outputs enabled		12	13	13	15	15	
		Outputs disabled		1	2	2	2	2	
C_{pdB} ⁽¹⁾	A to B	Outputs enabled	$C_L = 0,$ $f = 10\text{ MHz},$ $t_r = t_f = 1\text{ ns}$	12	13	13	14	16	pF
		Outputs disabled		1	2	2	2	2	
	B to A	Outputs enabled		3	3	3	4	4	
		Outputs disabled		1	1	1	2	2	

(1) Power dissipation capacitance per transceiver. Refer to the TI application report, CMOS Power Consumption and Cpd Calculation, [SCAA035](#)

5.12 Typical Characteristics

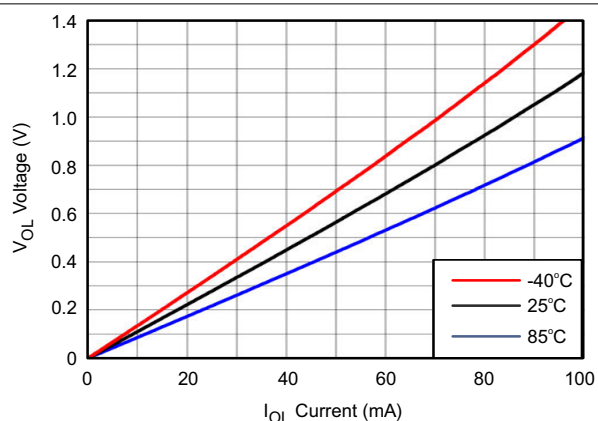


图 5-1. V_{OL} Voltage vs I_{OL} Current

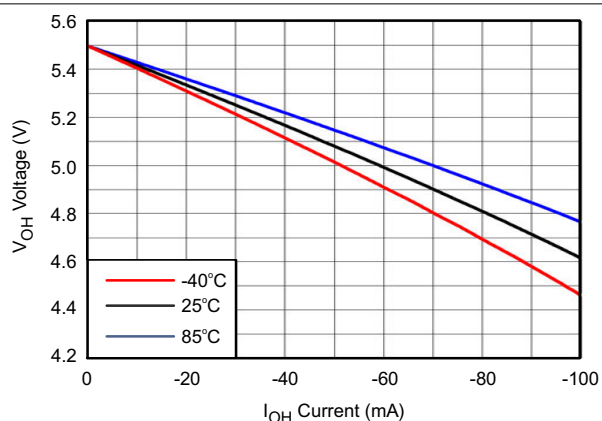
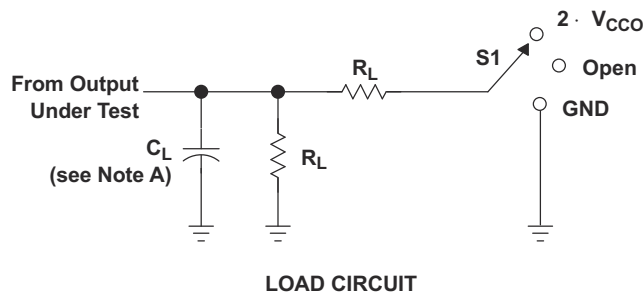


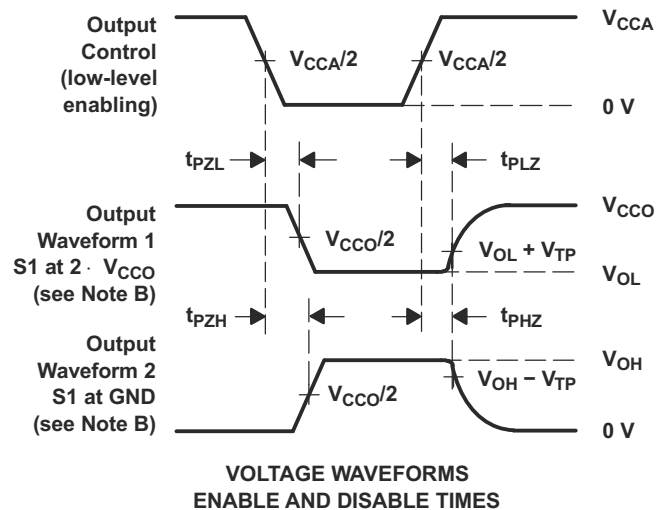
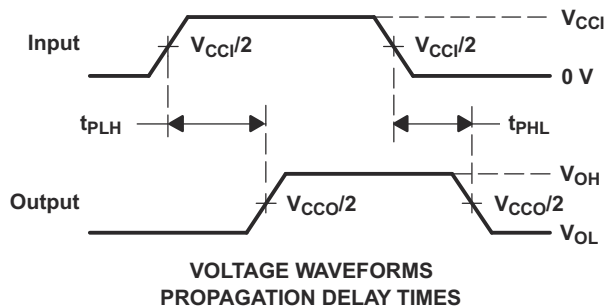
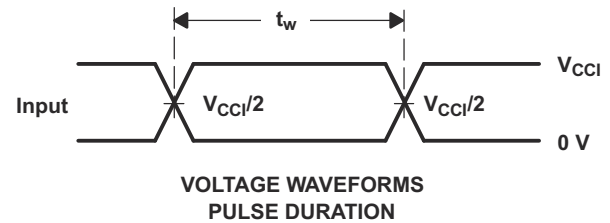
图 5-2. V_{OH} Voltage vs I_{OH} Current

6 Parameter Measurement Information



TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	$2 \cdot V_{CCO}$
t_{PHZ}/t_{PZH}	GND

V_{CCO}	C_L	R_L	V_{TP}
1.2 V	15 pF	2 k Ω	0.1 V
1.5 V $\pm$ 0.1 V	15 pF	2 k Ω	0.1 V
1.8 V $\pm$ 0.15 V	15 pF	2 k Ω	0.15 V
2.5 V $\pm$ 0.2 V	15 pF	2 k Ω	0.15 V
3.3 V $\pm$ 0.3 V	15 pF	2 k Ω	0.3 V



- NOTES: A. C_L includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR = 10 MHz, $Z_O = 50 \Omega$, $dv/dt \geq 1$ V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLH} and t_{PHL} are the same as t_{pd} .
- F. V_{CCI} is the V_{CC} associated with the input port.
- G. V_{CCO} is the V_{CC} associated with the output port.

图 6-1. Load and Circuit and Voltage Waveforms

7 Detailed Description

7.1 Overview

The SN74AVC2T245 is a dual-bit, dual-supply noninverting bidirectional voltage level translation. Pins A and control pins (DIR and $\overline{OE}$) are supported by V_{CCA} and pins B are supported by V_{CCB} . The A port can accept I/O voltages ranging from 1.2 V to 3.6 V, while the B port can accept I/O voltages from 1.2 V to 3.6 V. A high on DIR allows data transmission from A to B and a low on DIR allows data transmission from B to A when $\overline{OE}$ is set to low. When $\overline{OE}$ is set to high, both A and B are in the high-impedance state.

This device is fully specified for partial-power-down applications using off output current (I_{off}).

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, both ports are put in a high-impedance state.

7.2 Functional Block Diagram

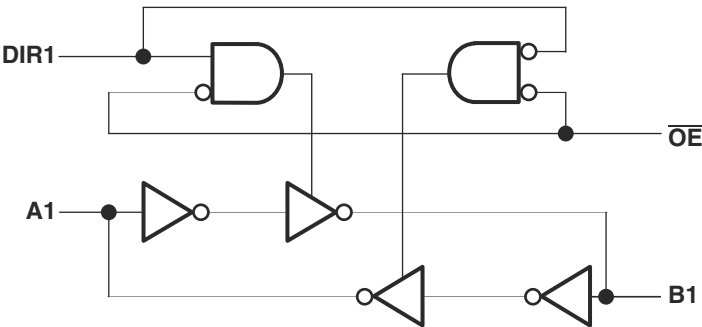


图 7-1. Logic Diagram (Positive Logic)

7.3 Feature Description

7.3.1 Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2 V to 3.6 V Power-Supply Range

Both V_{CCA} and V_{CCB} can be supplied at any voltage from 1.2 V to 3.6 V making the device suitable for translating between any of the low voltage nodes (1.2 V, 1.8 V, 2.5 V, and 3.3 V).

7.3.2 Partial-Power-Down Mode Operation

This device is fully specified for partial-power-down applications using off output current (I_{off}). The I_{off} circuitry will prevent backflow current by disabling I/O output circuits when device is in partial power-down mode.

7.3.3 V_{CC} Isolation

The V_{CC} isolation feature ensures that if either V_{CCA} or V_{CCB} are at GND, both ports will be in a high-impedance state (I_{OZ}). This prevents false logic levels from being presented to either bus.

7.4 Device Functional Modes

The SN74AVC2T245 is a voltage level translator that can operate from 1.2 V to 3.6 V (V_{CCA}) and 1.2 V to 3.6 V (V_{CCB}). The signal translation requires direction control and output enable control. The table below enlists the operation of the part for the respective states of the control inputs.

表 7-1. Function Table (Each Transceiver)

CONTROL INPUTS ⁽¹⁾		OUTPUT CIRCUITS		OPERATION
$\overline{OE}$	DIR1	A PORT	B PORT	
L	L	Enabled	Hi-Z	B data to A data
L	H	Hi-Z	Enabled	A data to B data

表 7-1. Function Table (Each Transceiver) (续)

CONTROL INPUTS ⁽¹⁾		OUTPUT CIRCUITS		OPERATION
OE	DIR1	A PORT	B PORT	
H	X	Hi-Z	Hi-Z	Isolation

(1) Input circuits of the data I/Os are always active.

8 Application and Implementation

备注

以下应用部分中的信息不属于 TI 器件规格的范围，TI 不担保其准确性和完整性。TI 的客户应负责确定器件是否适用于其应用。客户应验证并测试其设计，以确保系统功能。

8.1 Application Information

The SN74AVC2T245 is used to shift IO voltage levels from one voltage domain to another. Bus A and bus B have independent power supplies, and a direction pin is used to control the direction of data flow. Unused data ports must not be floating; tie the unused port input and output to ground directly.

8.1.1 Enable Times

Calculate the enable times for the SN74AVC16T45 using the following formulas:

$$t_{PZH} \text{ (DIR to A)} = t_{PLZ} \text{ (DIR to B)} + t_{PLH} \text{ (B to A)} \quad (1)$$

$$t_{PZL} \text{ (DIR to A)} = t_{PHZ} \text{ (DIR to B)} + t_{PHL} \text{ (B to A)} \quad (2)$$

$$t_{PZH} \text{ (DIR to B)} = t_{PLZ} \text{ (DIR to A)} + t_{PLH} \text{ (A to B)} \quad (3)$$

$$t_{PZL} \text{ (DIR to B)} = t_{PHZ} \text{ (DIR to A)} + t_{PHL} \text{ (A to B)} \quad (4)$$

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the SN74AVC2T245 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

8.2 Typical Application

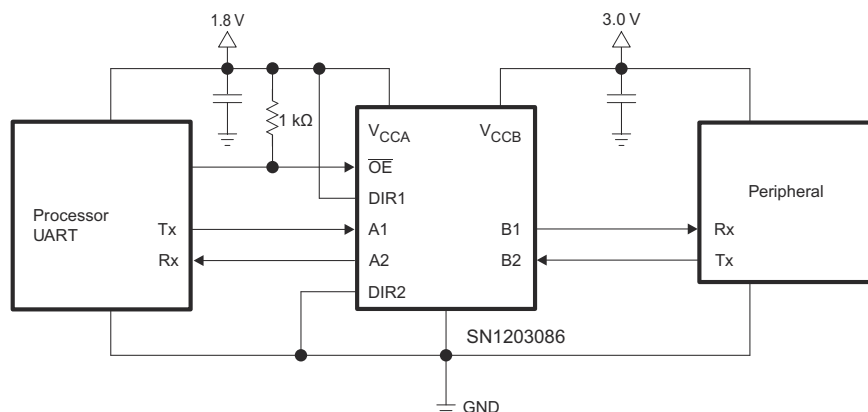


图 8-1. Typical Application of the SN74AVC2T245

8.2.1 Design Requirements

This device uses drivers which are enabled depending on the state of the DIR pin. The designer must know the intended flow of data and take care not to violate any of the high or low logic levels. Unused data inputs must not be floating, as this can cause excessive internal leakage on the input CMOS structure. Tie any unused input and output ports directly to ground.

For this design example, use the parameters listed in 表 8-1.

表 8-1. Design Parameters

DESIGN PARAMETER	EXAMPLE VALUE
Input voltage range	1.2 V to 3.6 V
Output voltage range	1.2 V to 3.6 V

8.2.2 Detailed Design Procedure

To begin the design process, determine the following:

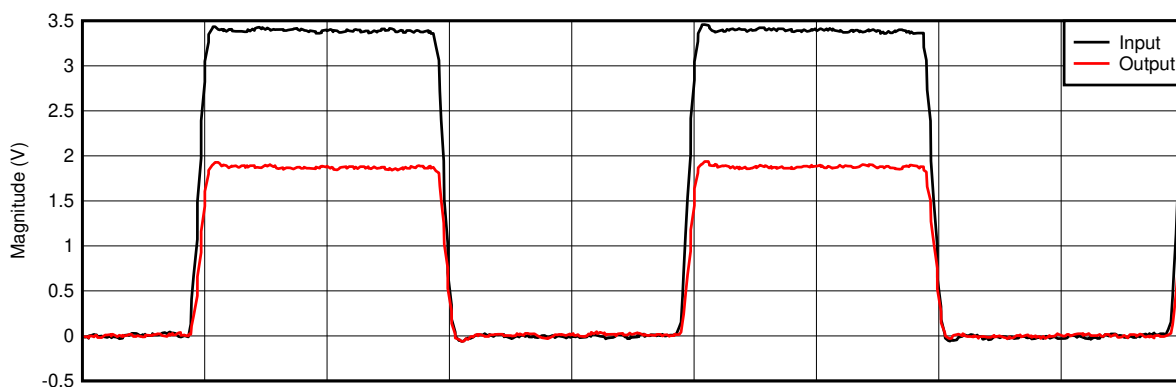
8.2.2.1 Input Voltage Ranges

Use the supply voltage of the device that is driving the SN74AVC2T245 device to determine the input voltage range. For a valid logic high the value must exceed the V_{IH} of the input port. For a valid logic low the value must be less than the V_{IL} of the input port.

8.2.2.2 Output Voltage Range

Use the supply voltage of the device that the SN74AVC2T245 device is driving to determine the output voltage range.

8.2.3 Application Curves



D001

图 8-2. 3.3 V to 1.8 V Level-Shifting With 1-MHz Square Wave

9 Power Supply Recommendations

The SN74AVC2T245 device uses two separate configurable power-supply rails, V_{CCA} and V_{CCB} . V_{CCA} accepts any supply voltage from 1.2 V to 3.6 V and V_{CCB} accepts any supply voltage from 1.2 V to 3.6 V. The A port and B port are designed to track V_{CCA} and V_{CCB} respectively allowing for low-voltage bidirectional translation between any of the 1.2 V, 1.5 V, 1.8 V, 2.5 V, 3.3 V and 5 V voltage nodes.

10 Layout

10.1 Layout Guidelines

To ensure reliability of the device, following common printed-circuit-board layout guidelines is recommended.

- Bypass capacitors should be used on power supplies.
- Short trace lengths should be used to avoid excessive loading.
- Placing pads on the signal paths for loading capacitors or pullup resistors to help adjust rise and fall times of signals depending on the system requirements.

10.2 Layout Example

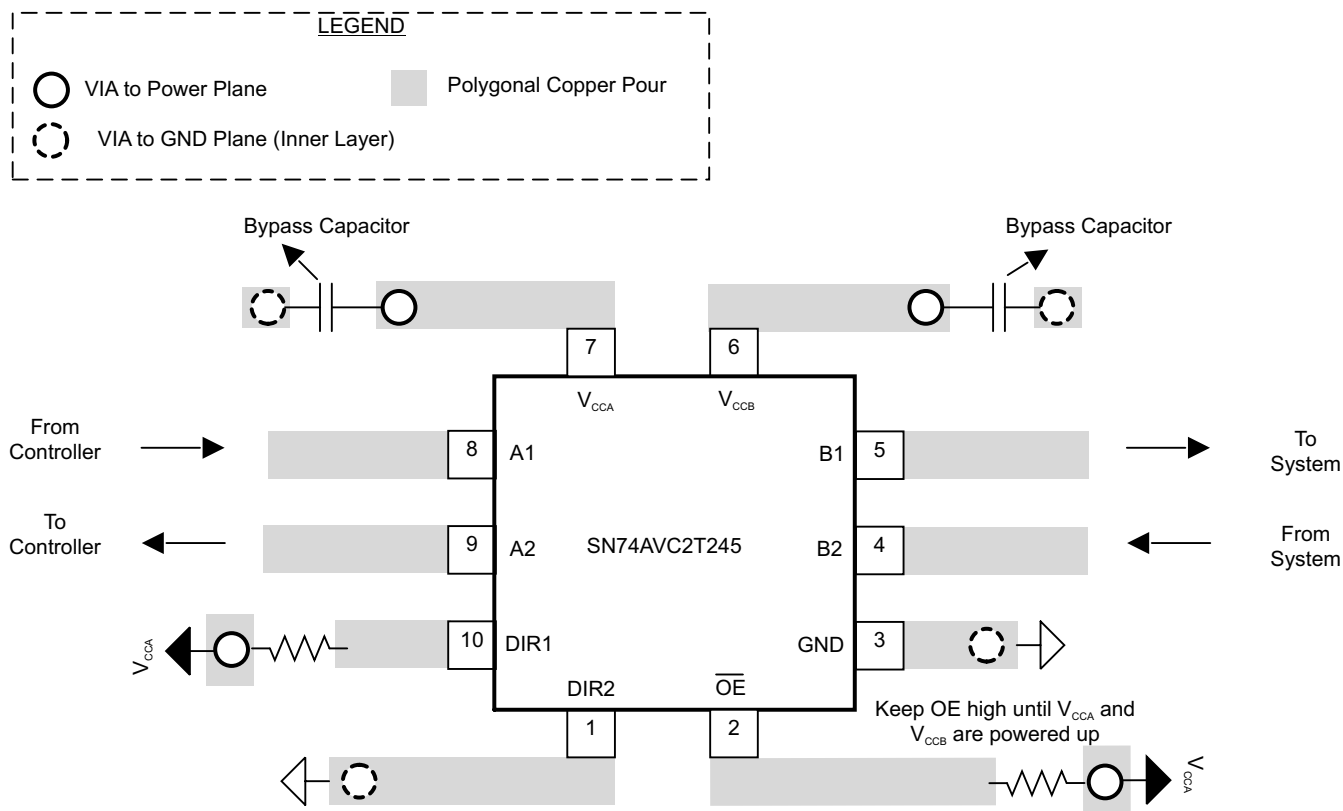


图 10-1. Recommended Layout Example

11 Device and Documentation Support

11.1 接收文档更新通知

要接收文档更新通知，请导航至 [ti.com](https://www.ti.com) 上的器件产品文件夹。点击 [通知](#) 进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

11.2 支持资源

[TI E2E™ 中文支持论坛](#) 是工程师的重要参考资料，可直接从专家处获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题，获得所需的快速设计帮助。

链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的 [使用条款](#)。

11.3 Trademarks

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11.4 静电放电警告



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ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

11.5 术语表

[TI 术语表](#) 本术语表列出并解释了术语、首字母缩略词和定义。

12 Revision History

注：以前版本的页码可能与当前版本的页码不同

Changes from Revision D (February 2016) to Revision E (September 2024)	Page
• 更新了整个文档中的表格、图和交叉参考的编号格式.....	1
• Updated Thermal Information.....	5

Changes from Revision C (July 2015) to Revision D (February 2016)	Page
• 更改了 引脚配置和功能	1

Changes from Revision B (June 2015) to Revision C (July 2015)	Page
• The <i>Ordering Information</i> table (formally on page 1) contained a Top-Side Marking of TQ_. The table has been replaced with the Package Option Addendum in Mechanical, Packaging, and Orderable Information . VC_ was added to the device marking	18

Changes from Revision A (May 2012) to Revision B (June 2015)	Page
• 添加了 引脚配置和功能 部分、 <i>ESD</i> 等级表、特性说明 部分、器件功能模式、应用和实施 部分、电源相关建议 部分、布局 部分、器件和文档支持 部分以及机械、封装和可订购信息 部分.....	1
• 删除了“订购信息”表。.....	1

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74AVC2T245RSWR	Active	Production	UQFN (RSW) 10	3000 LARGE T&R	Yes	NIPDAU NIPDAUAG	Level-1-260C-UNLIM	-40 to 85	(TQ7, TQO, TQR, TQ V) (TQH, TQJ, TQY) (VCH, VCO) (VCJ, VCR)
SN74AVC2T245RSWR.A	Active	Production	UQFN (RSW) 10	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(TQ7, TQO, TQR, TQ V) (TQH, TQJ, TQY) (VCH, VCO) (VCJ, VCR)
SN74AVC2T245RSWR.B	Active	Production	UQFN (RSW) 10	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(TQ7, TQO, TQR, TQ V) (TQH, TQJ, TQY) (VCH, VCO) (VCJ, VCR)
SN74AVC2T245RSWRG4.A	Active	Production	UQFN (RSW) 10	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TQV TQY
SN74AVC2T245RSWRG4.B	Active	Production	UQFN (RSW) 10	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TQV TQY

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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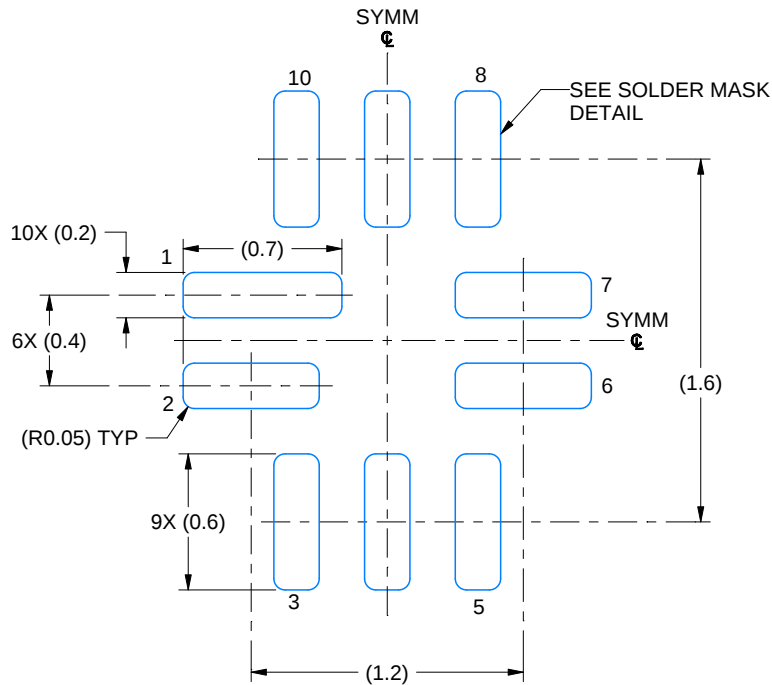
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package complies to JEDEC MO-288 variation UDEE, except minimum package height.

EXAMPLE BOARD LAYOUT

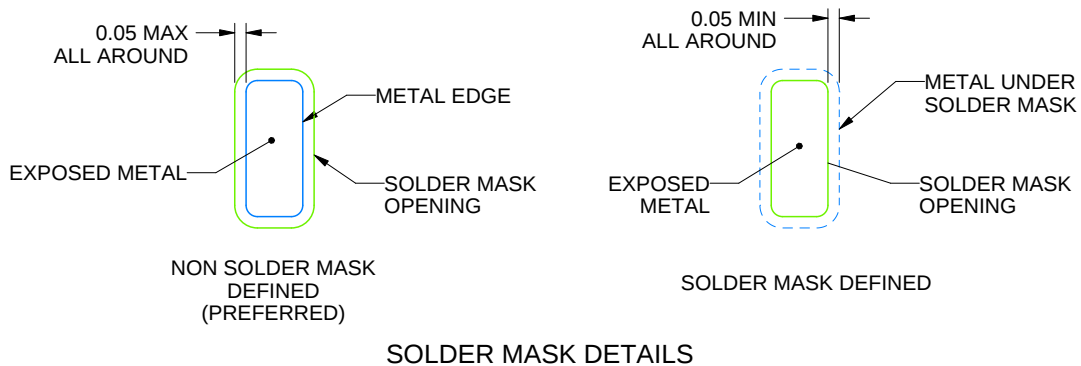
RSW0010A

UQFN - 0.55 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 30X



SOLDER MASK DETAILS

4224897/A 03/2019

NOTES: (continued)

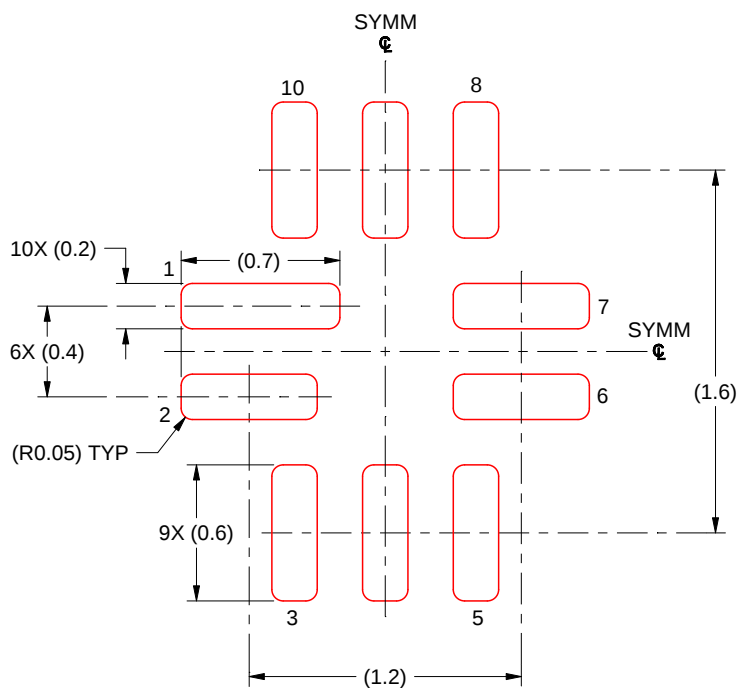
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slue271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN

RSW0010A

UQFN - 0.55 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 MM THICK STENCIL
SCALE: 30X

4224897/A 03/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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最后更新日期：2025 年 10 月